TOSHIBA BIPOLAR DIGITAL INTEGRATED CIRCUIT SILICON MONOLITHIC

# TD62783AP,TD62783F,TD62783AF TD62784AP,TD62784F,TD62784AF

### 8CH HIGH-VOLTAGE SOURCE DRIVER

The TD62783AP / F / AF Series are comprised of eight source current Transistor Array.

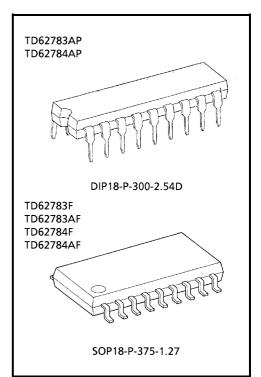
These drivers are specifically designed for fluorescent display applications.

Applications include relay, hammer and lamp drivers.

#### FEATURES

- High output voltage Type-AP, AF :  $V_{CC} = 50 \text{ V MIN}$ . Type-F :  $V_{CC} = 35 \text{ V MIN}$ .
- Output current (single output) IOUT = -500 mA MIN.
- Output clamp diodes
- Single supply voltage
- Input compatible with various types of logic
- Package Type-AP : DIP-18 pin
- Package Type-F, AF : SOP-18 pin

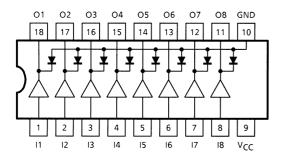
TYPE	DESIGNATION			
TD62783AP / F / AF	TTL, 5 V CMOS			
TD62784AP / F / AF	6~15 V PMOS, CMOS			



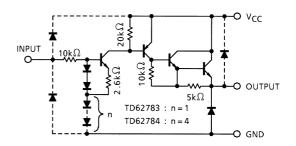
Weight

DIP18-P-300-2.54D : 1.47 g (Typ.) SOP18-P-375-1.27 : 0.41 g (Typ.)

#### **PIN CONNECTION (TOP VIEW)**



#### SCHEMATICS (EACH DRIVER)



Note: The input and output parasitic diodes cannot be used as clamp diodes.

## MAXIMUM RATINGS (Ta = 25°C)

CHARACTERIST	SYMBOL	RATING	UNIT		
Supply Voltage	AP, AF	V <sub>CC</sub>	50	V	
Supply voltage	F	VCC	35	v	
Output Current	IOUT	-500	mA / ch		
Input Voltage		V <sub>IN</sub> (Note 1)	15	V	
		V <sub>IN</sub> (Note 2)	30		
Clamp Diode Reverse	AP, AF	V <sub>R</sub>	50	V	
Voltage	F	٧R	35	v	
Clamp Diode Forward Curre	١ <sub>F</sub>	500	mA		
Rower Dissipation	AP	P <sub>D</sub> (Note 3)	1.47	W	
Power Dissipation	F, AF	FD (NOLE 3)	0.96	vv	
Operating Temperature	T <sub>opr</sub>	-40~85	°C		
Storage Temperature	T <sub>stg</sub>	-55~150	°C		

Note 1: Only TD62783AP / F / AF

Note 2: Only TD62784AP / F / AF

Note 3: Delated above 25°C in the proportion of 11.7 W / °C (AP Type), 7.7 W / °C (F, AF Type)

# **RECOMMENDED OPERATING CONDITIONS (Ta = -40~85°C)**

CHARACTERISTIC			SYMBOL	TEST CONDITION		MIN	TYP.	MAX	UNIT	
Supply Voltage		AP, AF	Mara	_		_	_	50	v	
		F	V <sub>CC</sub>	_			_	35		
						Duty = 10% 8Circuits	-	_	-260	
Output Current				Ta = 85°C	Duty = 50% 8Circuits	-	_	-59	mA /	
Α			IOUT	T <sub>j</sub> = 120°C T <sub>pw</sub> = 25ms	Duty = 10% 8Circuits	-	_	-180	ch	
		AF, F			Duty = 50% 8Circuits	-	_	-38		
Input \/o	TD62783AP /		/ F / AF	Mar.	—		-	_	12	V
Input Voltage TD62784AP		/ F / AF	V <sub>IN</sub>	_		_	_	24	v	
	Output On	TD62783AP	/ F / AF	Variation	_		2.0	5.0	15	V
Input		TD62784AP	/ F / AF	V <sub>IN (ON)</sub>	—		4.5	12.0	30	
Voltage	Output Off	TD62783AP	/ F / AF		—		0	_	0.8	
		TD62784AP	/ F / AF	V <sub>IN (OFF)</sub>	_		0	_	2.0	
		AP	<i>M</i> _	_		_	_	50	v	
		F, AF	V <sub>R</sub>	_		-	_	35	v	
Clamp Diode Forward Current		١ <sub>F</sub>	_		_	_	400	mA		
Power Dissipation F, AF		P-	—		_	_	0.52	w		
		F, AF	PD				_	0.35	vv	

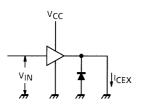
# ELECTRICAL CHARACTERISTICS (Ta = 25°C)

CHARACTERISTIC		SYMBOL	TEST CIR- CUIT	TEST CONDITION	MIN	TYP.	MAX	UNIT		
Output Leakage Current		ICEX	1	V <sub>CC</sub> = V <sub>CC MAX</sub> . V <sub>IN</sub> = 0.4 V Ta = 25°C	_	_	100	μA		
				2	V <sub>IN</sub> = V <sub>IN (ON)</sub> , I <sub>OUT</sub> = -350 mA	_	_	2.0		
Output Saturation Voltage		V <sub>CE (sat)</sub>	V <sub>IN</sub> = V <sub>IN (ON)</sub> , I <sub>OUT</sub> = -225 mA		_	_	1.9	V		
			$V_{IN} = V_{IN (ON)},$ $I_{OUT} = -100 \text{ mA}$		_	_	1.8			
	TD62783AP / F / AF		IIN (ON)		V <sub>IN</sub> = 2.4 V	—	36	52	μΑ	
Input Current				3	V <sub>IN</sub> = 3.85 V	_	180	260		
	TD62784AP / F / AF				V <sub>IN</sub> = 5 V	_	92	130		
					V <sub>IN</sub> = 12 V	_	790	1130		
	TD62783A	TD62783AP / F / AF		- 4	V <sub>CE</sub> = 2.0 V	_	_	2.0		
Input	TD62784AP / F / AF		VIN (ON)		I <sub>OUT</sub> = −350 mA	_	_	4.5	v	
Voltage	TD62783AP / F / AF		V <sub>IN (OFF)</sub>		I <sub>OUT</sub> = −500 μA	0.8	_	_		
	TD62784AP / F / AF					2.0	_	-		
Supply Current		ICC (ON)	3	$V_{IN} = V_{IN (ON)}, V_{CC} = 50 V$	_	_	2.5	mA / ch		
Clamp Diode AP, AF Reverse Current F		I <sub>R</sub>	5	V <sub>R</sub> = 50 V	_	_	50	μA		
				V <sub>R</sub> = 35 V	_	_	50			
Clamp Diode Forward Voltage		V <sub>F</sub>	6	I <sub>F</sub> = 350 mA	_	_	2.0	V		
Turn-On Delay		t <sub>ON</sub>	7	V <sub>CC</sub> = V <sub>CC MAX</sub> . R <sub>L</sub> = 125 Ω	_	0.15	_	116		
Turn-Off D	Turn-Off Delay		t <sub>OFF</sub>	<i>'</i>	C <sub>L</sub> = 15 pF, R <sub>L</sub> = 88 Ω (F)	_	1.8	_	μs	

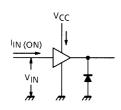
# <u>TOSHIBA</u>

## **TEST CIRCUIT**

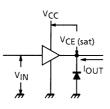
1. ICEX



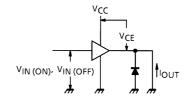
3. I<sub>IN (ON)</sub>, I<sub>CC</sub>



2. V<sub>CE (sat)</sub>

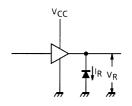


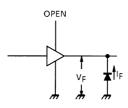
4. V<sub>IN (ON)</sub>, V<sub>IN (OFF)</sub>



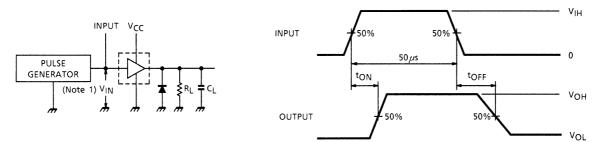
5. I<sub>R</sub>

6. V<sub>F</sub>





7. t<sub>ON</sub>, t<sub>OFF</sub>



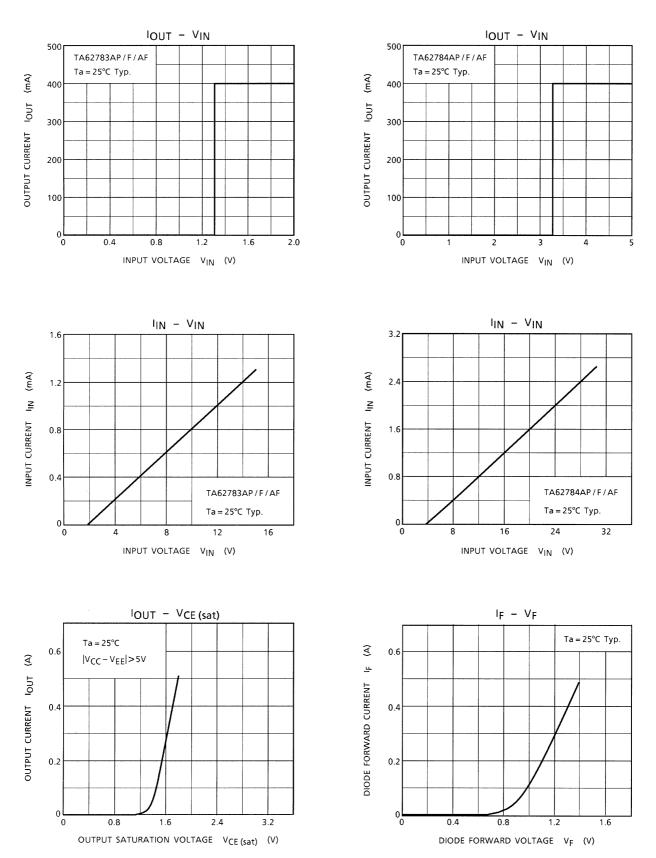
Note 1: Pulse width 50  $\mu$ s, duty cycle 10% Output impedance 50  $\Omega$ , t<sub>f</sub> ≤ 5 ns, t<sub>f</sub> ≤ 10 ns Note 2: C<sub>L</sub> includes probe and jig capacitance

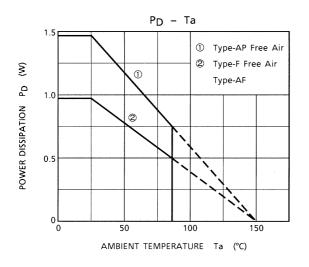
# **PRECAUTIONS for USING**

This IC does not integrate protection circuits such as overcurrent and overvoltage protectors. Thus, if excess current or voltage is applied to the IC, the IC may be damaged. Please design the IC so that excess current or voltage will not be applied to the IC.

Utmost care is necessary in the design of the output line,  $V_{CC}$  and GND line since IC may be destroyed due to short-circuit between outputs, air contamination fault, or fault by improper grounding.

# **TOSHIBA**



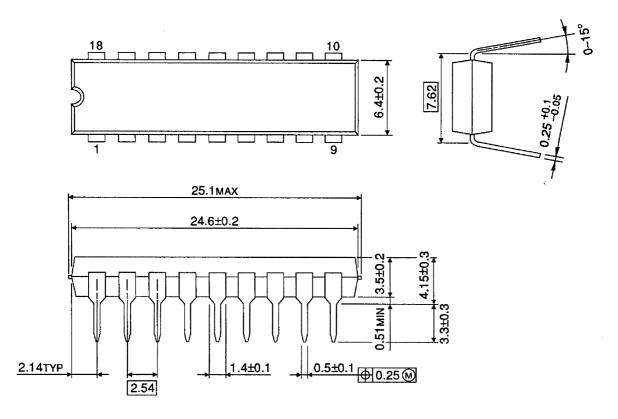


# TOSHIBA

#### PACKAGE DIMENSIONS

DIP18-P-300-2.54D

Unit: mm



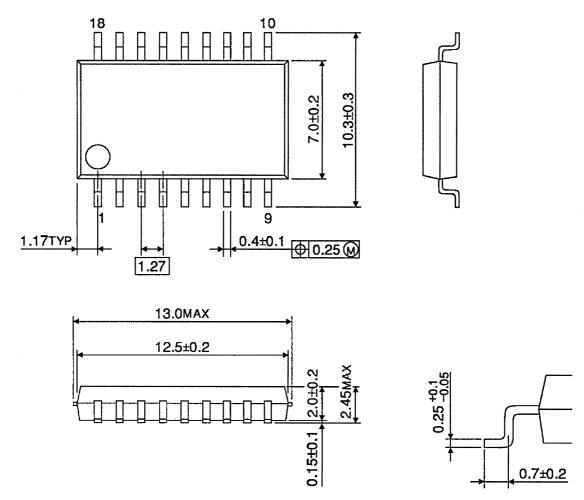
Weight: 1.47 g (Typ.)

# **TOSHIBA**

### PACKAGE DIMENSIONS

SOP18-P-375-1.27

Unit: mm



Weight: 0.41 g (Typ.)

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